

Title (en)

Method and apparatus for adjusting the gap between the rollers in a glue applicator for corrugated board

Title (de)

Verfahren und Vorrichtung zur Regelung der Höhe eines Walzenspaltes einer Beleimungs-Vorrichtung für eine Wellpappe-Bahn

Title (fr)

Dispositif de réglage de l'espacement de cylindres dans une machine d'encollage de papier ondulé

Publication

**EP 1199152 A3 20040107 (DE)**

Application

**EP 01122994 A 20010926**

Priority

DE 10052372 A 20001020

Abstract (en)

[origin: EP1199152A2] The frame (1) contains a glue-applicator roller (5) rotarily driven on a center lengthwise axle (8), and a pressure roller (10) rotarily driven on a center lengthwise axle (11). A corrugated cardboard web (47) consisting of at least one covering web (50) and corrugated web (49) travels through the gap (53) between the glue-applicator and pressure rollers. A dynamometer (34) measures the actual force in the gap at right angles to the web. The height of the gap can be altered by an adjustment (36), and a regulator (43) compares the actual and nominal forces in the gap.

IPC 1-7

**B31F 1/28; B05C 1/08**

IPC 8 full level

**B31F 1/24** (2006.01); **B05C 1/08** (2006.01); **B05C 11/10** (2006.01); **B05D 1/28** (2006.01); **B05D 3/00** (2006.01); **B05D 3/12** (2006.01);  
**B05D 7/00** (2006.01); **B05D 7/24** (2006.01); **B31F 1/28** (2006.01)

CPC (source: EP US)

**B05C 1/083** (2013.01 - EP US); **B31F 1/2818** (2013.01 - EP US)

Citation (search report)

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US10543654B2; US11260616B2

Designated contracting state (EPC)

AT BE CH CY DE DK ES FI FR GB GR IE IT LI LU MC NL PT SE TR

DOCDB simple family (publication)

**EP 1199152 A2 20020424; EP 1199152 A3 20040107;** DE 10052372 A1 20020502; JP 2002192637 A 20020710; US 2002046811 A1 20020425;  
US 6620455 B2 20030916

DOCDB simple family (application)

**EP 01122994 A 20010926;** DE 10052372 A 20001020; JP 2001316944 A 20011015; US 98279801 A 20011022